## : ©hipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


## Contact us

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Ripac Vario 3 U, 6 U, 9 U


Material/surface finish:
Side panels
2.5 mm aluminum, clear-chromated
flanges and horizontal rails:
Extruded aluminum section, clear-chromated

## Supply includes:

Flanges, side panels,
horizontal rails, threaded inserts, insulating strips or $Z$ rails.
Tests:
Shock and vibration tested to:
IEC 600-68-2-6 test Fc
IEC 600-68-2-27 test Ea

## Standards:

Ripac subracks are based on the system dimensions of IEC 60 297-3.


1 Top: for backplane Bottom: for connector


EMC
upgradeable
B = Width
= Depth


3 Top: for backplane Bottom: for connector



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## Standards:

Ripac subracks are based on
the system dimensions of IEC 60 297-3.


B = Width
T = Depth
EMC

## upgradeable



1 Top: for backplane Bottom: for connector


2 Top: for backplane Bottom: for connector


3 Top: for backplane $(6 U+1 U)$
4 Bottom: for backplane $(6 U+2 \times 1 / 2 U)$


